



Docket No. 5000-5118

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JFW
Fee Only

Applicant(s) : Tomohei SUGIYAMA et al. Group Art Unit: 2891
Serial No : 10/626,418 Examiner: D. Menz
Filed : July 23, 2003
For : METHOD OF MANUFACTURING A LOW EXPANSION MATERIAL
AND SEMICONDUCTOR DEVICE USING THE LOW EXPANSION
MATERIAL

RESPONSE TO REQUIREMENT FOR RESTRICTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In the May 4, 2005 Office Action, the Examiner issued a restriction requirement,
requiring Applicants to elect one of four groups of claims:

- I. "Claim 1-8, drawn to a method of manufacturing a low expansion material,
classified in class 75, subclass 330";
- II. "Claims 9-10, drawn to a semiconductor device, classified in class 257, subclass
741";
- III. "Claims 11-12, drawn to a semiconductor device with a semiconductor element
mounted directly to a heat sink, classified in class 257, subclass 707"; or
- IV. "Claims 13-14, drawn to a semiconductor device with a heat releasing plate,
classified in class 257, subclass 712."

Applicants provisionally elect Group III, claims 11-12.

Applicants furthermore respectfully traverse the Examiner's restriction requirement.